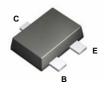


July 2007

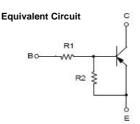
# FJY4002R PNP Epitaxial Silicon Transistor

## **Features**

- · Switching circuit, Inverter, Interface circuit, Driver Circuit
- Built in bias Resistor ( $R_1=10K\Omega$ ,  $R_2=10K\Omega$ )
- Complement to FJY3002R







# Absolute Maximum Ratings \* Ta = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V <sub>CBO</sub>	Collector-Base Voltage	-50	V	
V <sub>CEO</sub>	Collector-Emitter Voltage	-50	V	
V <sub>EBO</sub>	Emitter-Base Voltage	-10	V	
I <sub>C</sub>	Collector Current	-100	mA	
T <sub>STG</sub>	Storage Temperature Range	-55~150	°C	
T <sub>J</sub>	Junction Temperature	150	°C	
P <sub>C</sub>	Collector Power Dissipation, by $R_{\theta JA}$	200	mW	

С

# Thermal Characteristics\* Ta=25°C unless otherwise noted

R <sub>AJA</sub> Thermal Resistance, Junction to Ambient 600	Max Units	Parameter	Symbol
00/1	600 °C/W	Thermal Resistance, Junction to Ambient	

# Electrical Characteristics\* T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Condition	MIN	Тур	MAX	Units
V <sub>(BR)</sub> CBO	Collector-Emitter Breakdown Voltage	Ic = -10 uA, IE = 0	-50			V
V <sub>(BR)</sub> CEO	Collector-Base Breakdown Voltage	Ic = -100 uA, IB = 0	-50			V
Ісво	Collector-Cutoff Current	Vcb = -40 V, IE = 0			-0.1	uA
hfe	DC Current Gain	Vce = -5 V, Ic = -5mA	30			
VcE(sat)	Collector-Emitter Saturation Voltage	Ic = -10 mA, I <sub>B</sub> = -0.5 mA			-0.3	V
f⊤	Current Gain - Bandwidth Product	VcE = -10V, Ic = -5 mA		200		MHz
Ccb	Output Capacitance	Vcb = -10 V, IE = 0, f = 1.0 MHz		5.5		pF
Vı(off)	Input Off Voltage	Vce = -5 V, Ic = -100uA	-0.5			V
V <sub>I</sub> (on)	Input On Voltage	VcE = -0.3V, Ic = -10mA			-3	V
R <sub>1</sub>	Input Resistor		7	10	13	ΚΩ
R <sub>1</sub> /R <sub>2</sub>	Resistor Ratio		0.9	1.0	1.1	

<sup>\*</sup> Pulse Test: PW≤300μs, Duty Cycle≤2%

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may by impaired.

# **Typical Performance Characteristics**

Figure 1. DC current Gain

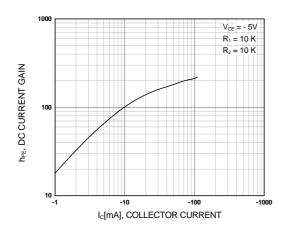


Figure 3. Input off Voltage

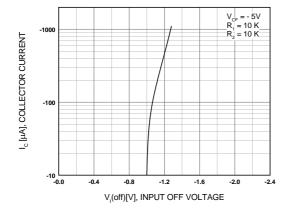


Figure 2. Input On Voltage

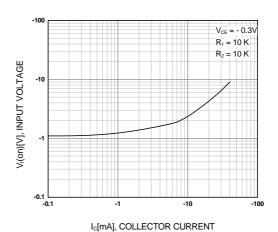
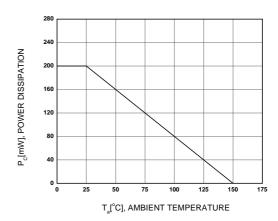


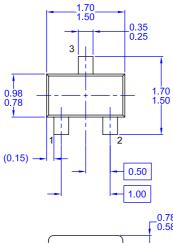
Figure 4. Power Derating

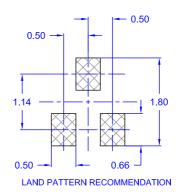


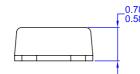
2

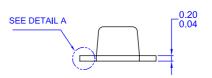
# **Package Dimensions**

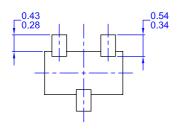
# **SOT-523F**

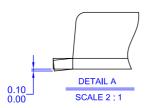












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B) ALL DIMENSIONS ARE IN MILLIMETERS.
C) DIMENSIONS ARE EXCLUSIVE OF BURRS,
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Dimensions in Millimeters





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Datasheet Identification	Product Status	Definition
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Rev. I25



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# **FJY4003R**

NPN EPITAXIAL SILICON TRANSISTOR

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- Features
- Product status/pricing/packaging
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- Qualification Support

#### **Features**

- Switching circuit, Inverter, Interface circuit, Driver Circuit
- Built in bias Resistor (R1=10KΩ, R2=10KΩ)
- Complement to FJY3002R

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Product status/pricing/packaging

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Product	Product status	Pb-free Status	Pricing*	Package type	Leads	Packing method	Package Marking Convention**
FJY4003R	Full Production	Full Production	\$0.0485	SOT-523F	3	TAPE REEL	Line 1: S53

<sup>\*</sup> Fairchild 1,000 piece Budgetary Pricing

<sup>\*\*</sup> A sample button will appear if the part is available through Fairchild's on-line samples program. If there is no sample button, please contact a Fairchild distributor to obtain samples



Indicates product with Pb-free second-level interconnect. For more information click here.

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